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Kind regards,

Team Nexperia



# PDTD113/123/143/114EQA **Series** 50 V, 500 mA NPN resistor-equipped transistors

**Rev. 1 — 4 February 2016** 

**Product data sheet** 

#### **Product profile** 1.

#### 1.1 General description

NPN Resistor-Equipped Transistor (RET) family in a leadless ultra small DFN1010D-3 (SOT1215) Surface-Mounted Device (SMD) plastic package with visible and solderable side pads.

#### **Product overview** Table 1.

Type number	R1	R2	Package NXP	PNP complement
PDTD113EQA	1 kΩ	1 kΩ	DFN1010D-3	PDTB113EQA
PDTD123EQA	2.2 kΩ	2.2 kΩ	(SOT1215)	PDTB123EQA
PDTD143EQA	4.7 kΩ	4.7 kΩ		PDTB143EQA
PDTD114EQA	10 kΩ	10 kΩ		PDTB114EQA

#### 1.2 Features and benefits

- 500 mA output current capability
- Built-in bias resistors
- ± 10% resistor ratio tolerance
- Simplifies circuit design
- Reduces component count

#### 1.3 Applications

- Digital applications
- Cost saving alternative for BC807/BC817 series in digital applications

#### 1.4 Quick reference data

#### Reduced pick and place costs

- Low package height of 0.37 mm
- Suitable for Automatic Optical Inspection (AOI) of solder joint
- AEC-Q101 qualified
- Controlling IC inputs
- Switching loads

Table 2.	Quick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CEO</sub>	collector-emitter voltage	open base	-	-	50	V
I <sub>O</sub>	output current		-	-	500	mA



50 V, 500 mA NPN resistor-equipped transistors

### 2. Pinning information

Table 3.	Pinning			
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	I	input (base)		
2	GND	GND (emitter)		
3	0	output (collector)		
4	0	output (collector)	4   3     2   4   Transparent top view	GND

### 3. Ordering information

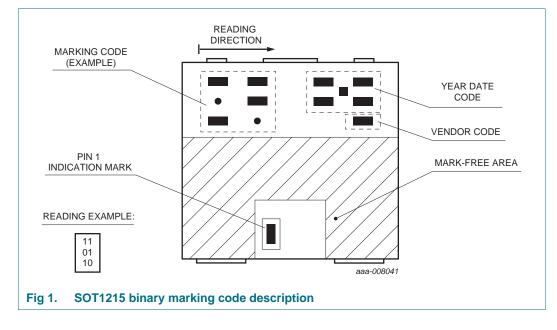
Table 4.         Ordering information							
Type number	Package						
	Name	Description	Version				
PDTD113EQA	DFN1010D-3	plastic thermal enhanced ultra thin small outline	SOT1215				
PDTD123EQA		package; no leads; 3 terminals; body: $1.1 \times 1.0 \times 0.37$ mm					
PDTD143EQA							
PDTD114EQA							

50 V, 500 mA NPN resistor-equipped transistors

#### 4. Marking

Table 5.   Marking codes							
Type number	Marking code						
PDTD113EQA	01 00 11						
PDTD123EQA	01 01 10						
PDTD143EQA	01 10 01						
PDTD114EQA	01 11 01						

#### 4.1 Binary marking code description



### 5. Limiting values

#### Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CBO</sub>	collector-base voltage	open emitter	-	50	V
V <sub>CEO</sub>	collector-emitter voltage	open base	-	50	V
V <sub>EBO</sub>	emitter-base voltage	open collector	-	10	V

50 V, 500 mA NPN resistor-equipped transistors

Symbol	Parameter	Conditions		Мах	Unit					
VI	input voltage	input voltage								
	PDTD113EQA		-10	+10	V					
	PDTD123EQA		-10	+12	V					
	PDTD143EQA		-10	+30	V					
	PDTD114EQA		-10	+50	V					
lo	output current		-	500	mA					
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	[1] -	325	mW					
			[2] _	575	mW					
			[3] _	525	mW					
			[4] _	940	mW					
Tj	junction temperature		-	150	°C					
T <sub>amb</sub>	ambient temperature		-55	+150	°C					
T <sub>stg</sub>	storage temperature		-65	+150	°C					

#### Table 6. Limiting values ...continued

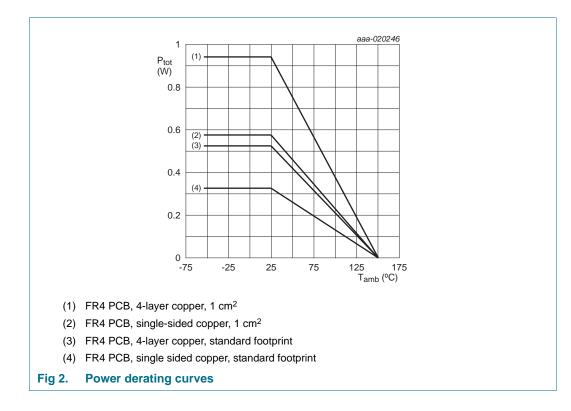
In accordance with the Absolute Maximum Rating System (IEC 60134).

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated; mounting pad for collector 1 cm<sup>2</sup>.

[3] Device mounted on an FR4 PCB, 4-layer copper, tin-plated and standard footprint.

[4] Device mounted on an FR4 PCB, 4-layer copper, tin-plated; mounting pad for collector 1 cm<sup>2</sup>.



50 V, 500 mA NPN resistor-equipped transistors

#### 6. Thermal characteristics

Table 7.	Thermal	characteristics
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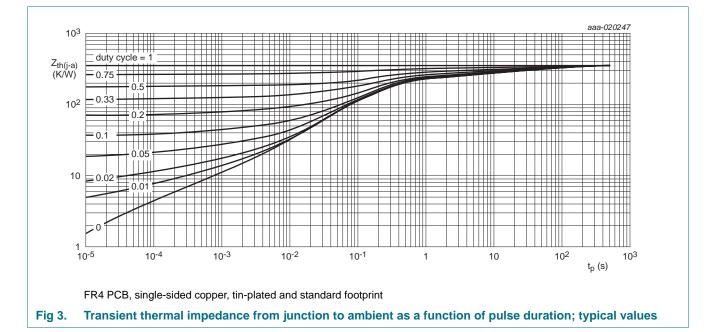
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction	in free air	[1]	-	-	385	K/W
	to ambient	[2]	[2]	-	-	218	K/W
			[3]	-	-	239	K/W
			[4]	-	-	133	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point			-	-	40	K/W

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated; mounting pad for collector 1 cm<sup>2</sup>.

[3] Device mounted on an FR4 PCB, 4-layer copper, tin-plated and standard footprint.

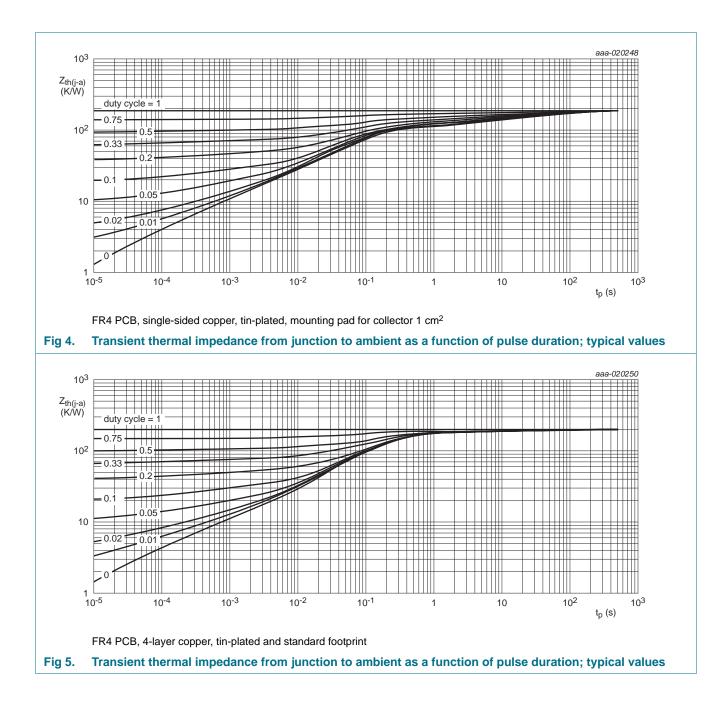
[4] Device mounted on an FR4 PCB, 4-layer copper, tin-plated; mounting pad for collector 1 cm<sup>2</sup>.



5 of 23

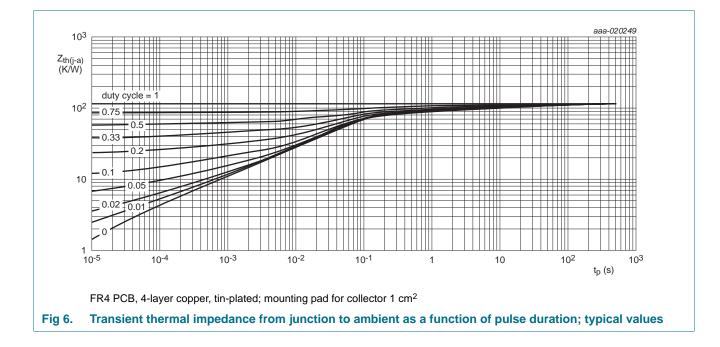
### PDTD113/123/143/114EQA

50 V, 500 mA NPN resistor-equipped transistors



# PDTD113/123/143/114EQA

50 V, 500 mA NPN resistor-equipped transistors



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### 7. Characteristics

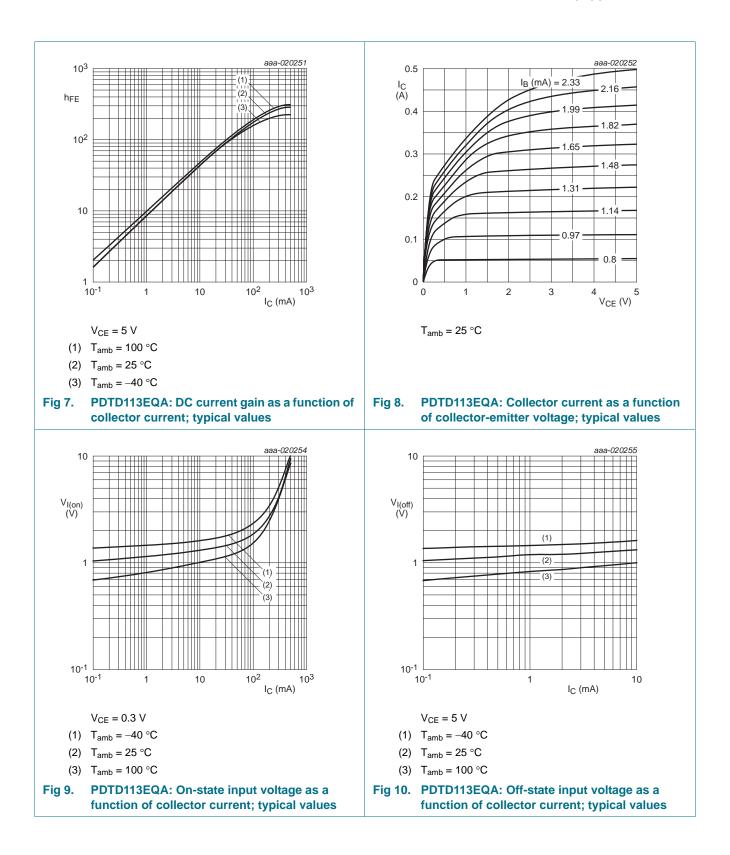
Symbol	Parameter	Conditions	Min	Тур	Max	Unit			
I <sub>СВО</sub>	collector-base cut-off current	V <sub>CB</sub> = 50 V; I <sub>E</sub> = 0 A		-	100	nA			
ICEO	collector-emitter cut-off current	V <sub>CE</sub> = 50 V; I <sub>B</sub> = 0 A	-	-	0.5	μA			
I <sub>EBO</sub>	emitter-base cut-off current								
	PDTD113EQA	$V_{EB} = 5 \text{ V}; \text{ I}_{C} = 0 \text{ A}$	-	-	4	mA			
	PDTD123EQA	-	-	-	2	mA			
	PDTD143EQA		-	-	0.9	mA			
	PDTD114EQA				0.4	mA			
h <sub>FE</sub>	DC current gain								
	PDTD113EQA	$V_{CE} = 5 \text{ V}; \text{ I}_{C} = 50 \text{ mA}$	33	-	-				
	PDTD123EQA		40	-	-				
	PDTD143EQA		60	-	-				
	PDTD114EQA			-	-				
V <sub>CEsat</sub>	collector-emitter saturation voltage	I <sub>C</sub> = 50 mA; I <sub>B</sub> = 2.5 mA		-	100	mV			
V <sub>I(off)</sub>	off-state input voltage	-							
	PDTD113EQA	$V_{CE} = 5 \text{ V}; \text{ I}_{C} = 100 \mu\text{A}$	0.6	1.05	1.5	V			
	PDTD123EQA	-	0.6	1.05	1.8	V			
	PDTD143EQA	-	0.6	1.05	1.5	V			
	PDTD114EQA	-	0.6	1.05	1.5	V			
V <sub>I(on)</sub>	on-state input voltage								
	PDTD113EQA	V <sub>CE</sub> = 0.3 V; I <sub>C</sub> = 20 mA	1	1.45	1.8	V			
	PDTD123EQA		1	1.5	2	V			
	PDTD143EQA		1	1.7	2.2	V			
	PDTD114EQA		1	2.2	3	V			
R1	bias resistor 1 (input)	1	1						
	PDTD113EQA		0.7	1	1.3	kΩ			
	PDTD123EQA		1.54	2.2	2.86	kΩ			
	PDTD143EQA		3.3	4.7	6.1	kΩ			
	PDTD114EQA		7	10	13	kΩ			
R2/R1	bias resistor ratio	·	1 0.9	1	1.1				
C <sub>c</sub>	collector capacitance	V <sub>CB</sub> = 10 V; I <sub>E</sub> = i <sub>e</sub> = 0 A; f = 1 MHz	-	5	-	pF			
fT	transition frequency	$V_{CE} = 5 \text{ V}; \text{ I}_{C} = 50 \text{ mA}; \text{ f} = 100 \text{ MHz}$	-	210	-	MHz			

[1] See section test information for resistor calculation and test conditions.

[2] Characteristics of built-in transistor.

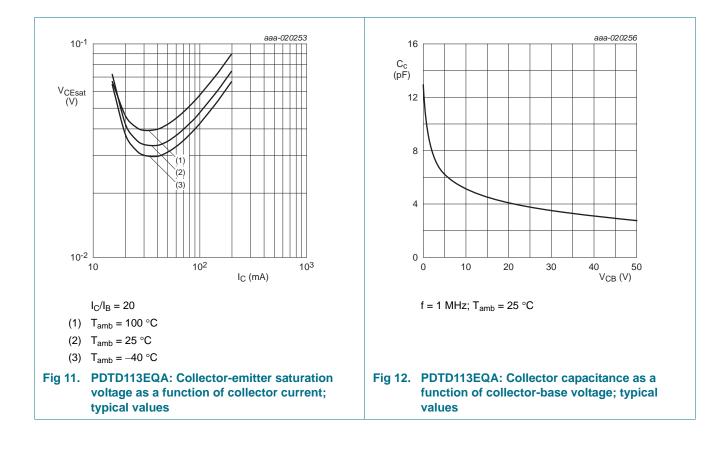
PDTD113\_123\_143\_114EQA\_SER Product data sheet

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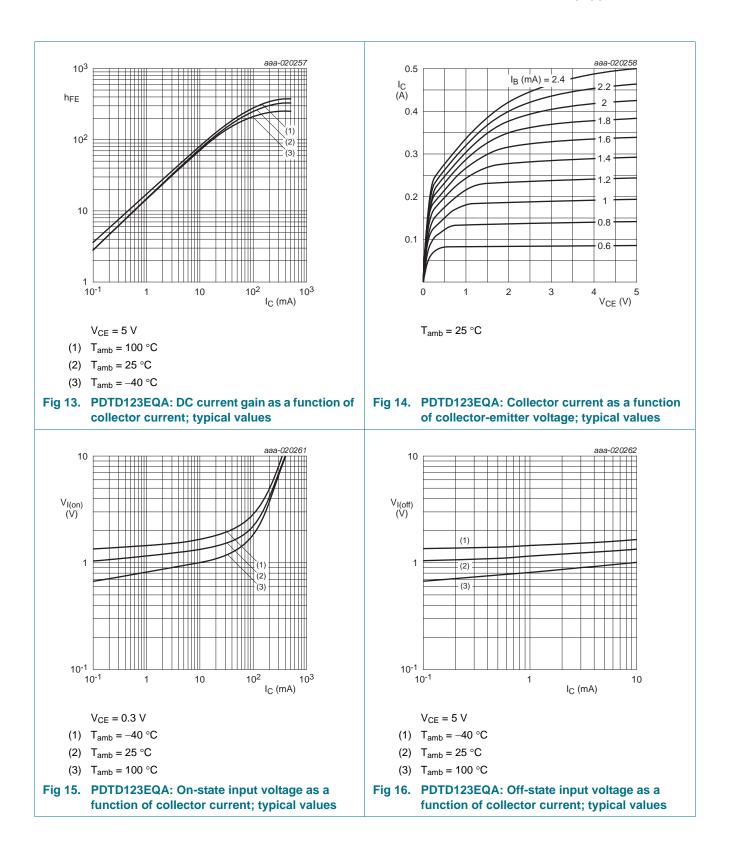


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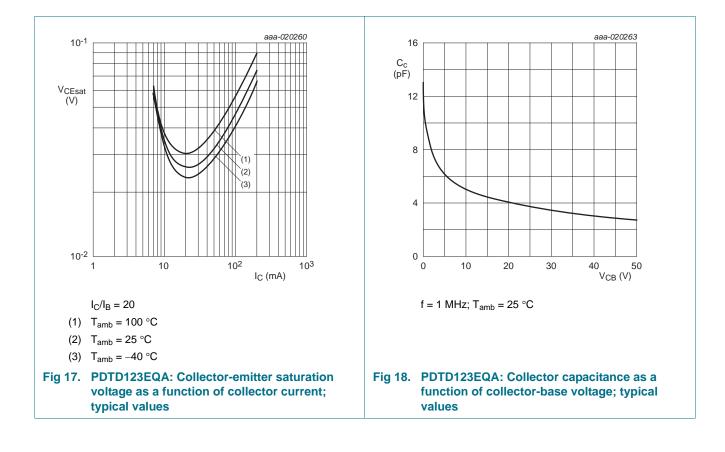


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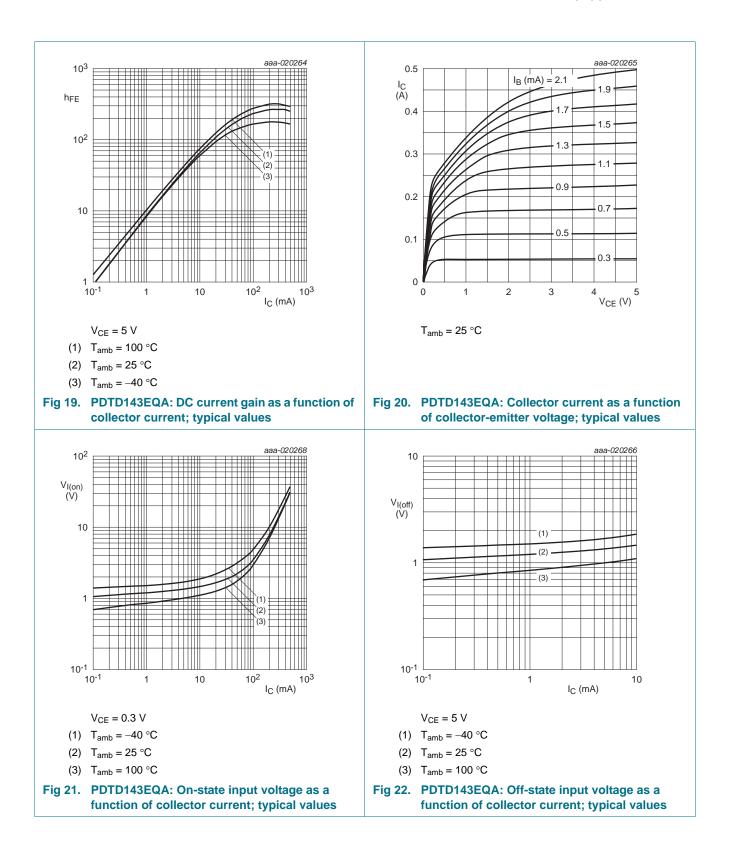


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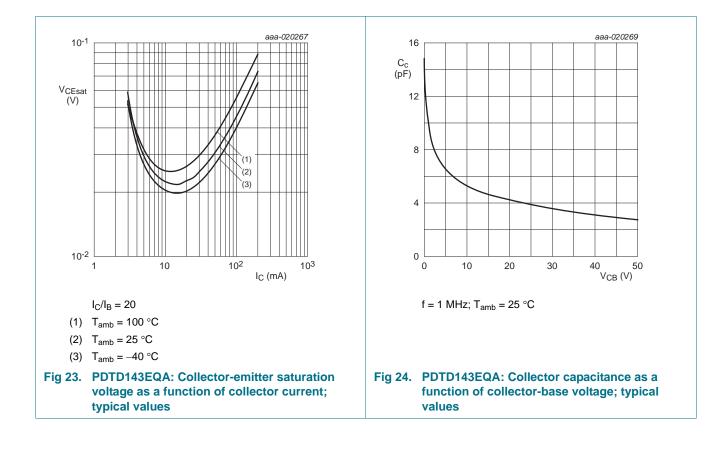


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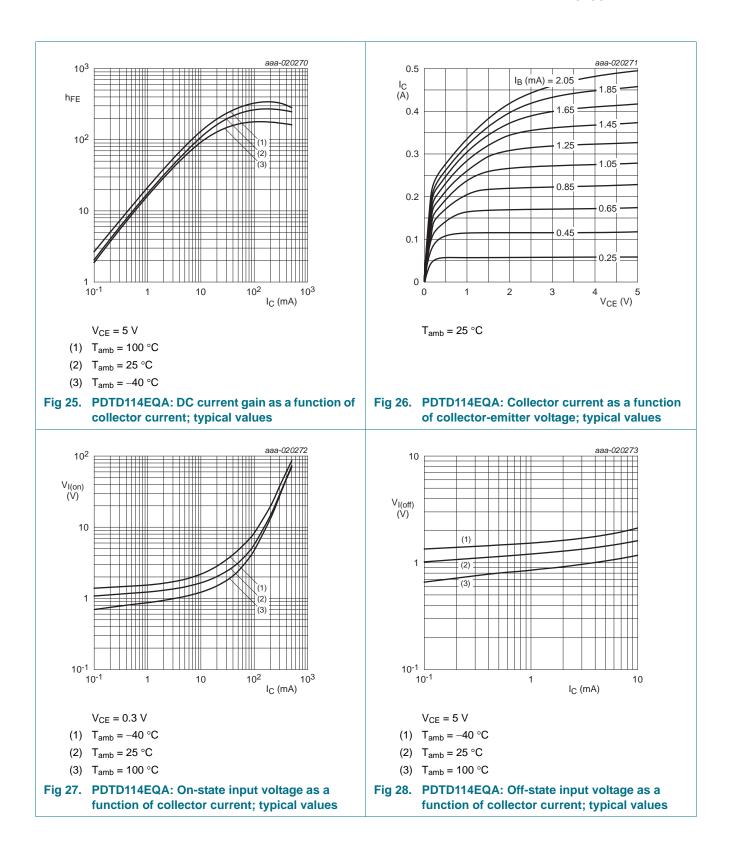


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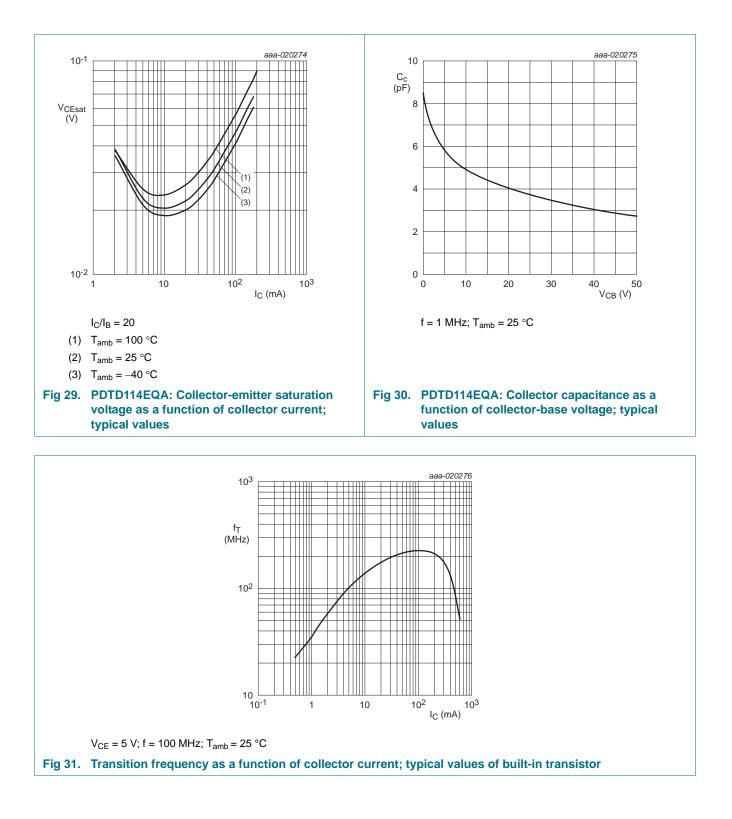


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# PDTD113/123/143/114EQA

50 V, 500 mA NPN resistor-equipped transistors



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50 V, 500 mA NPN resistor-equipped transistors

#### 8. Test information

#### 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

#### 8.2 Resistor calculation

• Calculation of bias resistor 1 (R1):

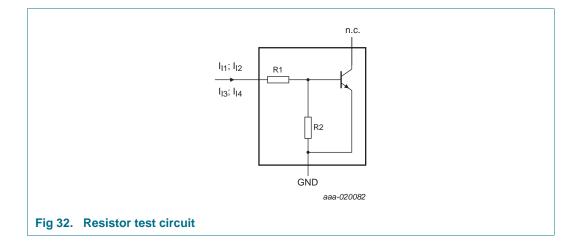
$$R1 = \frac{V(I_{12}) - V(I_{11})}{I_{12} - I_{11}}$$

• Calculation method A of bias resistor ratio (R2/R1):

$$\frac{R2}{R1} = \frac{V(I_{13})}{R1 \cdot I_{13}} - 1$$

• Calculation method B of bias resistor ratio (R2/R1):

$$\frac{R2}{R1} = \frac{V(I_{I4}) - V(I_{I3})}{R1 \cdot (I_{I4} - I_{I3})} - 1$$



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#### 8.3 Resistor test conditions

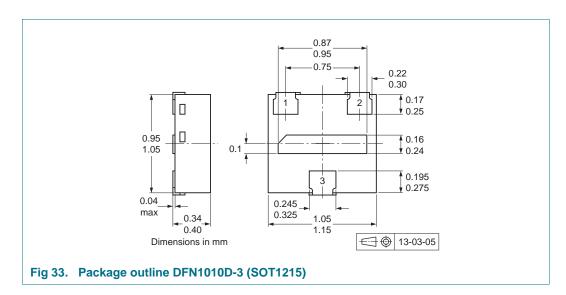
#### Table 9. Resistor test conditions

Type number		R1	R2	Test cond			
		kΩ	kΩ	I <sub>I1</sub>	I <sub>12</sub>	I <sub>13</sub>	I <sub>14</sub>
PDTD113EQA	<u>[1]</u>	1	1	1.5 mA	1.9 mA	–2.2 mA	-
PDTD123EQA	<u>[1]</u>	2.2	2.2	0.7 mA	0.8 mA	–0.75 mA	-
PDTD143EQA	[2]	4.7	4.7	1.3 mA	1.5 mA	–1.05 mA	–1.25 mA
PDTD114EQA	[2]	10	10	0.7 mA	0.8 mA	–0.45 mA	–0.55 mA

[1] Uses calculation method A of bias resistor ratio R2/R1

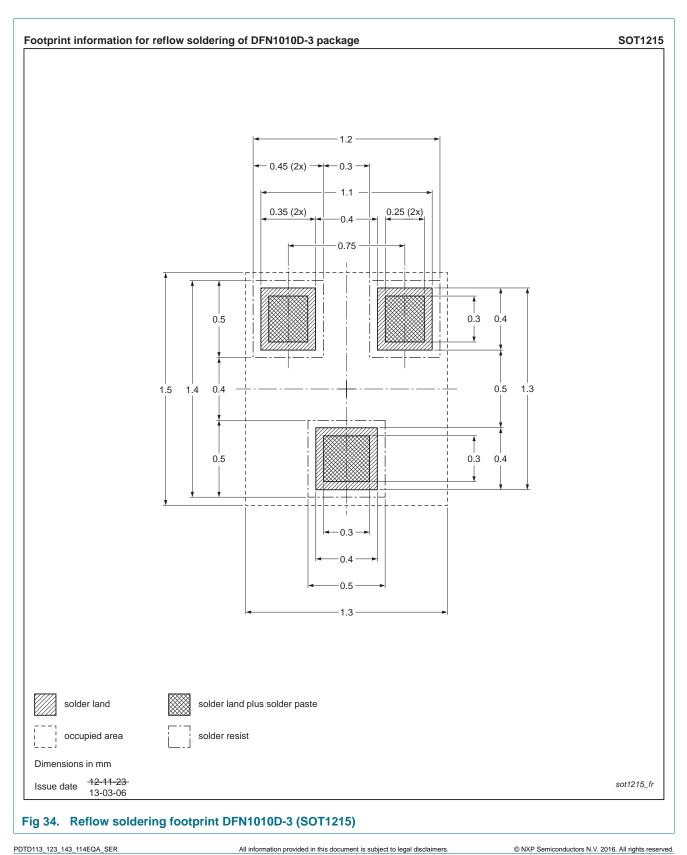
[2] Uses calculation method B of bias resistor ratio R2/R1

#### 9. Package outline



50 V, 500 mA NPN resistor-equipped transistors

### 10. Soldering



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### **11. Revision history**

#### Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PDTD113_123_143_114EQA_SER	20160104	Product data sheet	-	-
v.1				

50 V, 500 mA NPN resistor-equipped transistors

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Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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21 of 23

50 V, 500 mA NPN resistor-equipped transistors

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#### 14. Contents

1	Product profile 1
1.1	General description 1
1.2	Features and benefits 1
1.3	Applications 1
1.4	Quick reference data 1
2	Pinning information 2
3	Ordering information 2
4	Marking 3
4.1	Binary marking code description 3
5	Limiting values 3
6	Thermal characteristics 5
7	Characteristics 8
8	Test information 15
8.1	Quality information 15
8.2	Resistor calculation 15
8.3	Resistor test conditions 15
9	Package outline 16
10	Soldering 17
11	Revision history 18
12	Legal information 19
12.1	Data sheet status 19
12.2	Definitions 19
12.3	Disclaimers
12.4	Trademarks
13	Contact information 20
14	Contents 21

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